



## **Product Summary**

BV <sub>DSS</sub>	Rds(on)	ID TA = +25°C
00) (	85mΩ @ V <sub>GS</sub> = 10V	4.1A
60V	110mΩ @ V <sub>GS</sub> = 4.5V	3.6A

N-CHANNEL ENHANCEMENT MODE MOSFET

## Features and Benefits

- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

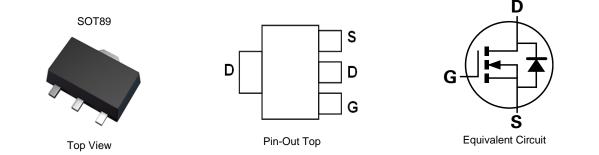
## **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- DC-DC converters
- Power-management functions
- Backlighting

## **Mechanical Data**

- Package: SOT89
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Finish Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.052 grams (Approximate)



## Ordering Information (Note 4)

Part Number	Deckere	Packing		
Part Number	Package	Qty.	Carrier	
DMN6070SY-13	SOT89	2,500	Reel	

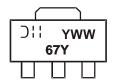
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



 $C_{++}^{++} = Manufacturer's Marking$ 67Y = Product Type Marking CodeYWW = Date Code Marking $Y or <math>\overline{Y}$  = Year (ex: 4 = 2024) WW = Week (01 to 53)



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage	Vdss	60	V		
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	ID	4.1 3.3	A		
Pulsed Drain Current (10µs Pulse, Duty Cycle ≦ 1%)			I <sub>DM</sub>	15	А
Maximum Body Diode Continuous Current (Note 6)			ls	2.5	A
Pulsed Body Diode Current (10µs Pulse, Duty Cycle ≦ 1%)			lsм	15	A
Avalanche Current, L = 0.1mH (Note 7)			las	11	A
Avalanche Energy, L = 0.1mH (Note 7)			Eas	6	mJ

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.9	W
Thermal Registeries, Junction to Ambient (Note E)	Steady State	D	122	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	RθJA	72	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	58	°C/W
mermai Resistance, Junction to Ambient (Note 6)	t < 10s	R <sub>θJA</sub>	34	°C/W
Thermal Resistance, Junction to Case (Note 6)		Rejc	12	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

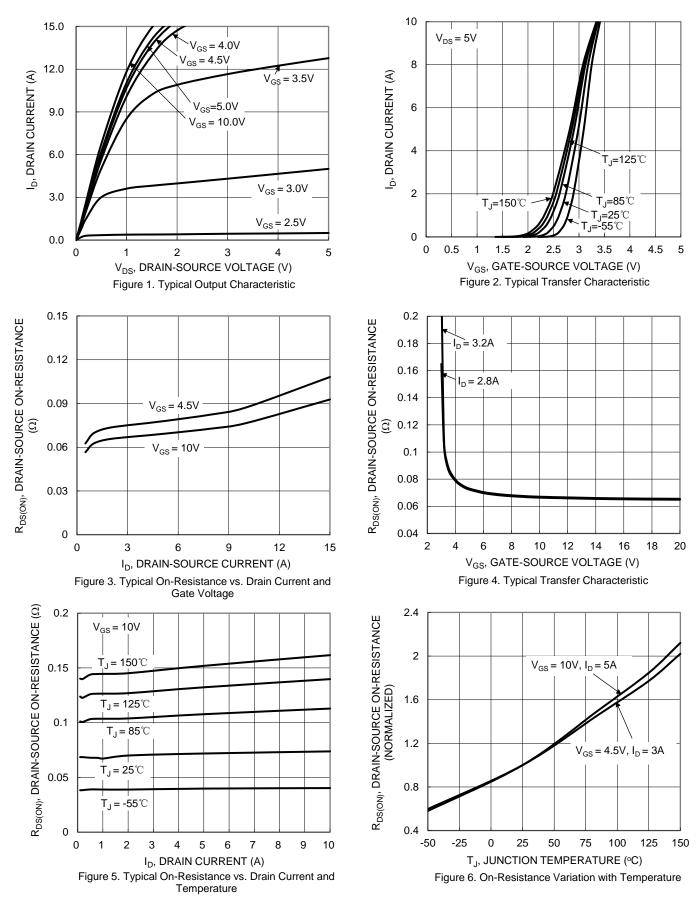
			_				
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)					1	1	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60			V	$I_D = 250 \mu A, V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	IDSS	_	—	1	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	Igss		—	±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	Vgs(th)	1.0	_	3.0	V	$I_D = 250 \mu A$ , $V_{DS} = V_{GS}$	
Static Drain-Source On-Resistance	Deserve		70	85		$V_{GS} = 10V, I_D = 2.5A$	
Static Drain-Source On-Resistance	RDS(ON)	_	76	110	mΩ	$V_{GS} = 4.5V, I_D = 1.5A$	
Diode Forward Voltage	Vsd	_	0.75	1.2	V	$I_{S} = 12A, V_{GS} = 0V$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		588	_			
Output Capacitance	Coss		26.5	—	pF	$V_{DS} = 30V, V_{GS} = 0V$ F = 1MHz	
Reverse Transfer Capacitance	Crss	_	20	_			
Gate Resistance	Rg	_	1.5	_	Ω	$V_{GS} = 0V$ , $V_{DS} = 0V$ , $f = 1MHz$ ,	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	5.6	_		V <sub>DS</sub> = 30V, I <sub>D</sub> = 3A	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	12.3	_			
Gate-Source Charge	Qgs	_	1.7	_	nC		
Gate-Drain Charge	Q <sub>gd</sub>	_	1.9	_			
Turn-On Delay Time	tD(ON)	_	3.5	_		$V_{DD} = 30V, V_{GS} = 10V$ $R_L \cong 50\Omega, R_g \cong 20\Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	4.1	_			
Turn-Off Delay Time	tD(OFF)	_	35	_	ns		
Turn-Off Fall Time	tF		11	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>		18	_	ns	I <sub>S</sub> = 12A, di/dt = 100A/µs	
Body Diode Reverse Recovery Charge	QRR		12	_	nC	Is = 12A, di/dt = 100A/µs	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

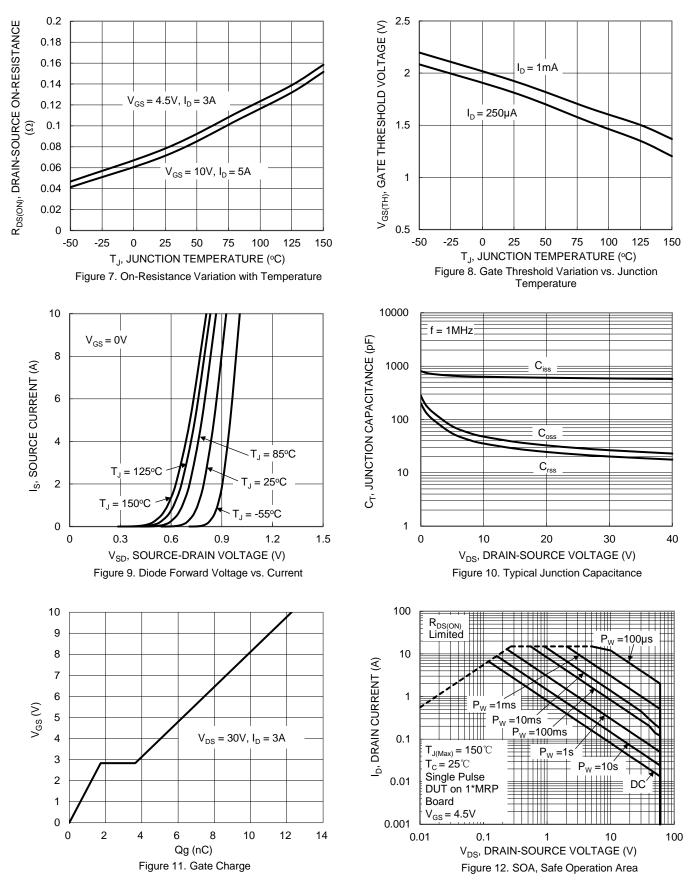
7. I<sub>AS</sub> and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ . 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.



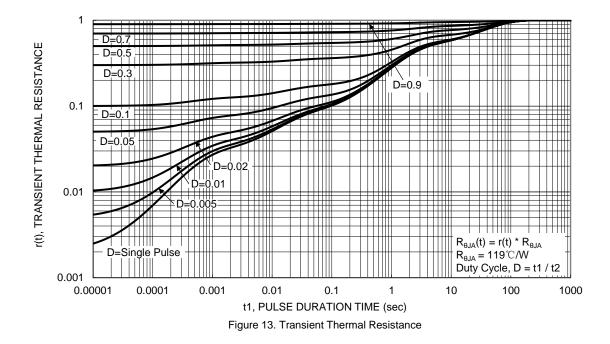




## DMN6070SY



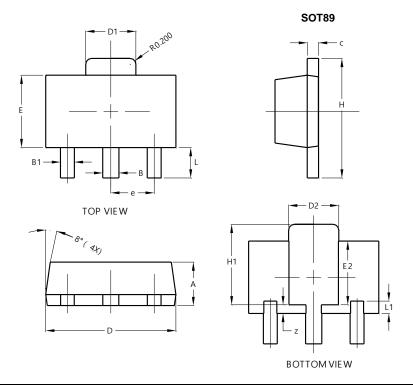






# **Package Outline Dimensions**

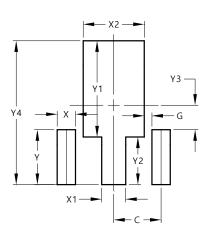
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT89						
Dim	Min	Max	Тур			
Α	1.40	1.60	1.50			
в	0.50	0.62	0.56			
B1	0.42	0.54	0.48			
c	0.35	0.43	0.38			
D	4.40	4.60	4.50			
D1	1.62	1.83	1.733			
D2	1.61	1.81	1.71			
ш	2.40	2.60	2.50			
E2	2.05	2.35	2.20			
e	-	-	1.50			
H	3.95	4.25	4.10			
H1	2.63	2.93	2.78			
L	0.90	1.20	1.05			
L1	0.327	0.527	0.427			
z	0.20	0.40	0.30			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



r			
Dimensions	Value (in mm)		
С	1.500		
G	0.244		
Х	0.580		
X1	0.760		
X2	1.933		
Y	1.730		
Y1	3.030		
Y2	1.500		
Y3	0.770		
Y4	4.530		

SOT89



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